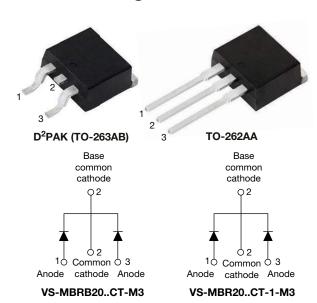
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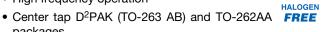
High Performance Schottky Rectifier, 2 x 10 A



PRIMARY CHARACTERISTICS						
I _{F(AV)} 2 x 10 A						
V_{R}	80 V, 90 V, 100 V					
V _F at I _F	0.70 V					
I _{RM} max.	6 mA at 125 °C					
T _J max.	150 °C					
E _{AS}	7 mJ					
Package	D ² PAK (TO-263AB), TO-262AA					
Circuit configuration	Common cathode					

FEATURES

- 150 °C T_J operation
- Low forward voltage drop
- High frequency operation



- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

This center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS								
SYMBOL	UNITS							
I _{F(AV)}	Rectangular waveform (per device)	20	٨					
I _{FRM}	T _C = 133 °C (per leg)	20	А					
V _{RRM}		80 to 100	V					
I _{FSM}	t _p = 5 μs sine	850	Α					
V _F	10 A _{pk} , T _J = 125 °C	0.70	V					
T _J	Range	-65 to +150	°C					

VOLTAGE RATINGS								
PARAMETER	SYMBOL			VS-MBRB20100CT-M3 VS-MBR20100CT-1-M3	UNITS			
Maximum DC reverse voltage	V_R	80	90	100	V			
Maximum working peak reverse voltage	V_{RWM}	00	90	100	V			



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ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum average per leg		T _C = 133 °C, rated V _R	10					
forward current per device	I _{F(AV)}	$I_C = 133$ C, rated v_R	20					
Peak repetitive forward current per leg	I _{FRM}	Rated V _R , square wave, 20 kHz, T _C = 133 °C	20					
Name and the control of the control		5 μs sine or Following any rated load condition 3 μs rect. pulse and with rated V _{RRM} applied	850	А				
Non-repetitive peak surge current	I _{FSM}	Surge applied at rated load conditions halfwave, single phase, 60 Hz	150					
Peak repetitive reverse surge current	I _{RRM}	2.0 μs, 1.0 kHz	0.5					
Non-repetitive avalanche energy per leg	E _{AS}	$T_J = 25 ^{\circ}\text{C}, I_{AS} = 2 \text{A}, L = 12 \text{mH}$	24	mJ				

ELECTRICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS			
		10 A	T _{.1} = 25 °C	0.80				
Maximum forward voltage drop	V _{FM} ⁽¹⁾	20 A	- Ij=25 C	0.95	V			
	V _{FM} ('')	10 A	T 405.00	0.70				
		20 A	- T _J = 125 °C	0.85				
Maximum instantaneous	1 (1)	T _J = 25 °C	T _J = 25 °C		Dated DC valtage	0.10	A	
reverse current	I _{RM} ⁽¹⁾	T _J = 125 °C	- Rated DC voltage	6	mA			
Threshold voltage	V _{F(TO)}	T T mayimum		0.433	V			
Forward slope resistance	r _t	$T_J = T_J$ maximum		15.8	mΩ			
Maximum junction capacitance	C _T	V _R = 5 V _{DC} (test signal range	400	pF				
Typical series inductance	L _S	Measured from top of term	8.0	nH				
Maximum voltage rate of change	dV/dt	Rated V _R	Rated V _R					

Note

 $^{^{(1)}\,}$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum junction tempe	rature range	TJ		-65 to 150	°C			
Maximum storage tempe	rature range	T _{Stg}		-65 to 175	C			
Maximum thermal resista junction to case per leg	nce,	R _{thJC}	DC operation	2.0				
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.50	°C/W			
Maximum thermal resistance, junction to ambient		R _{thJA}	DC operation	50				
Approximate weight				2	g			
Approximate weight				0.07	OZ.			
Maunting tayous	minimum		New July is acted three do	6 (5)	kgf · cm (lbf · in)			
Mounting torque	maximum		Non-lubricated threads	12 (10)				
Marking device			Case style D ² PAK (TO-263AB)	MBRB2 MBRB2 MBRB2	090CT			
			Case style TO-262AA	MBR209 MBR209 MBR201	90CT-1			

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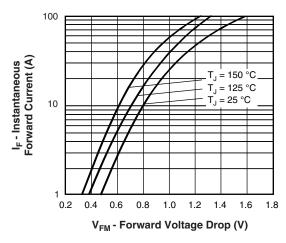


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

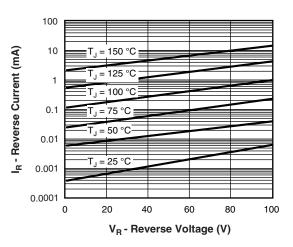


Fig. 2 - Typical Values of Reverse Current vs.Reverse Voltage (Per Leg)

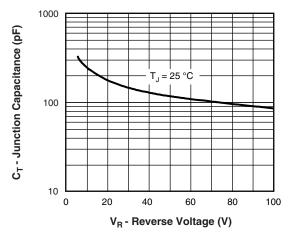


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

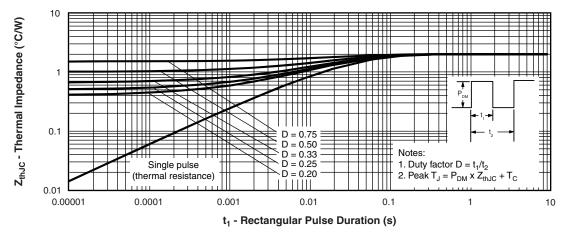


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics (Per Leg)

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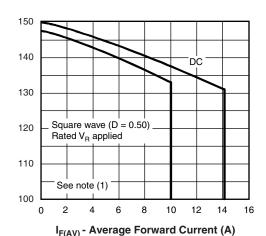


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

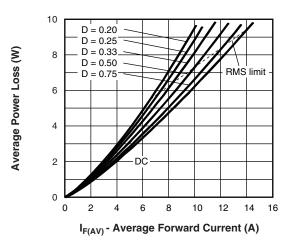


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

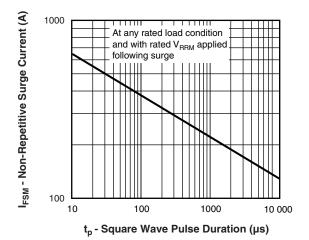


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

Note

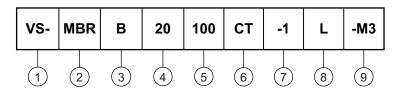
Allowable Case Temperature (°C)

 $^{(1)}$ Formula used: T_C = T_J - (Pd + Pd_{REV}) x R_{thJC}; Pd = forward power loss = I_{F(AV)} x V_{FM} at (I_{F(AV)}/D) (see fig. 6); Pd_{REV} = inverse power loss = V_{R1} x I_R (1 - D); I_R at V_{R1} = rated V_R

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ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

Essential part number

- • B = D²PAK (TO-263AB) **7** None

• None = TO-262AA 7 = -1

- Current rating (20 = 20 A)

Voltage ratings

6 - CT = essential part number

100 = 100 V

None

80 = 80 V 90 = 90 V

7 - • None = D²PAK (TO-263AB)3 = B

-1 = TO-262AANone = tube (50 pieces)

None = tube (50 pieces)
 L = tape and reel (left oriented - for D²PAK (TO-263AB) only)

• R = tape and reel (right oriented - for D²PAK (TO-263AB) only)

3

9 - -M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

ORDERING INFORMATION							
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION					
VS-MBRB20100CTL-M3	800	13" diameter plastic tape and reel					
VS-MBRB20100CT-M3	50	Antistatic plastic tubes					
VS-MBRB20100CTR-M3	800	13" diameter plastic tape and reel					
VS-MBRB2080CTL-M3	800	13" diameter plastic tape and reel					
VS-MBRB2080CT-M3	50	Antistatic plastic tubes					
VS-MBRB2080CTR-M3	800	13" diameter plastic tape and reel					
VS-MBRB2090CT-M3	50	Antistatic plastic tubes					
VS-MBR20100CT-1-M3	50	Antistatic plastic tubes					
VS-MBR2080CT-1-M3	50	Antistatic plastic tubes					
VS-MBR2090CT-1-M3	50	Antistatic plastic tubes					

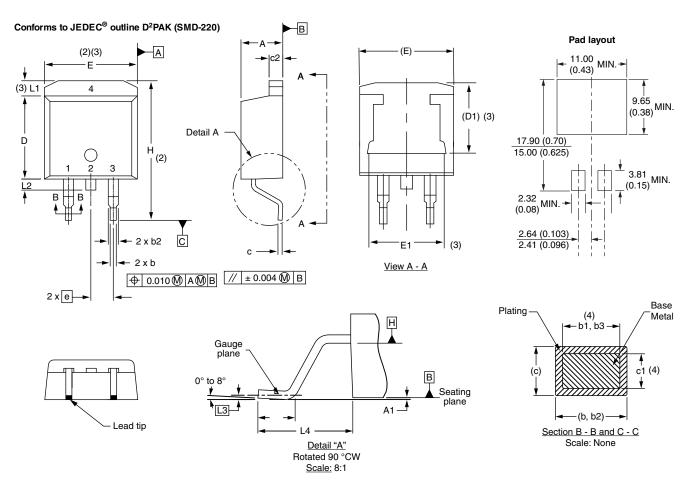
LINKS TO RELATED DOCUMENTS							
Dimensions	D ² PAK (TO-263AB)	www.vishay.com/doc?96164					
Dimensions	TO-262AA	www.vishay.com/doc?96165					
Part marking information	D ² PAK (TO-263AB)	www.vishay.com/doc?95444					
Part marking information	TO-262AA	www.vishay.com/doc?95443					
Packaging information		www.vishay.com/doc?96424					



Vishay Semiconductors

D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	ETERS	INCHES		NOTES	NOTES SYMBOL		MILLIM	ETERS	INC	HES	NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inches
- (7) Outline conforms to JEDEC® outline TO-263AB

Revision: 13-Jul-17 Document Number: 96164

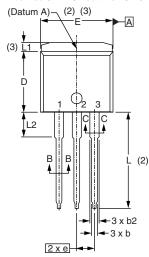


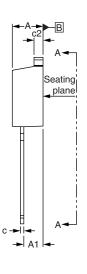
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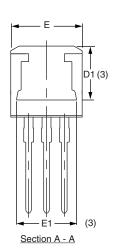
TO-262AA

DIMENSIONS in millimeters and inches

Modified JEDEC® outline TO-262







⊕ 0.010 **M** A**M** B

Lead assignments

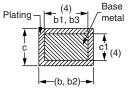


Diodes

1. - Anode (two die)/open (one die)

2., 4. - Cathode

3. - Anode



Section B - B and C - C Scale: None

SYMBOL	MILLIN	IETERS	INC	INCHES			
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES		
А	4.06	4.83	0.160	0.190			
A1	2.03	3.02	0.080	0.119			
b	0.51	0.99	0.020	0.039			
b1	0.51	0.89	0.020	0.035	4		
b2	1.14	1.78	0.045	0.070			
b3	1.14	1.73	0.045	0.068	4		
С	0.38	0.74	0.015	0.029			
c1	0.38	0.58	0.015	0.023	4		
c2	1.14	1.65	0.045	0.065			
D	8.51	9.65	0.335	0.380	2		
D1	6.86	8.00	0.270	0.315	3		
E	9.65	10.67	0.380	0.420	2, 3		
E1	7.90	8.80	0.311	0.346	3		
е	2.54 BSC		0.100	BSC			
L	13.46	14.10	0.530	0.555			
L1	-	1.65	-	0.065	3		
L2	3.56	3.71	0.140	0.146			

Notes

(4) Dimension b1 and c1 apply to base metal only

Controlling dimension: inches

⁽¹⁾ Dimensioning and tolerancing as per ASME Y14.5M-1994
(2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body

Thermal pad contour optional within dimension E, L1, D1 and E1

Outline conform to JEDEC® TO-262 except A1 (max.), b (min., max.), b1 (min.), b2 (max.), c (min.), c1(min.), c2 (max.), D (min.), E (max.), L1 (max.), L2 (min., max.)



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